



D1213A-04MR

#### 4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

### Features

- IEC 61000-4-2 (ESD): Air ±15kV, Contact ±8kV
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 0.85pF Typical
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: MSOP-10
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.026 grams (approximate)



# Ordering Information (Note 4)

| Part Number    | Case    | Packaging        |
|----------------|---------|------------------|
| D1213A-04MR-13 | MSOP-10 | 2500/Tape & Reel |

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and</li>

<1000ppm antimony compounds. 4. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**

Notes:



TV13 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 12 = 2012) WW = Week Code (01 ~ 53)



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                     | Symbol                          | Value  | Unit | Conditions             |
|------------------------------------|---------------------------------|--|------|------------------------|
| Operating Supply Voltage           | V <sub>P</sub> - V <sub>N</sub> | 6.0  | V    | -                      |
| DC Voltage at any Channel Input    | -                               | (V <sub>N</sub> – 0.5) to (V <sub>P</sub> + 0.5) | V    | -                      |
| Peak Pulse Current                 | IPP                             | 5  | A    | 8/20 μs, Per Fig. 3    |
| ESD Protection – Contact Discharge | V <sub>ESD_Contact</sub>        | ±8   | kV   | Standard IEC 61000-4-2 |
| ESD Protection – Air Discharge     | V <sub>ESD Air</sub>            | ±15  | kV   | Standard IEC 61000-4-2 |

# **Thermal Characteristics**

| Characteristic                                   | Symbol               | Value       | Unit |
|--|----------------------|-------------|------|
| Power Dissipation (Note 5)                       | PD                   | 500         | mW   |
| Thermal Resistance, Junction to Ambient (Note 5) | R <sub>0JA</sub>     | 250         | °C/W |
| Operating and Storage Temperature Range          | TJ, T <sub>STG</sub> | -65 to +150 | O°   |

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                        | Symbol           | Min  | Тур  | Max  | Unit | Test Conditions                                  |
|---------------------------------------|------------------|------|------|------|------|--|
| Operating Supply Voltage              | VP               | -    | 3.3  | 5.5  | V    | -  |
| Operating Supply Current (Note 6)     | I <sub>P</sub>   | -    | -    | 8.0  | μA   | $(V_{P} - V_{N}) = 3.3V$                         |
| Channel Leakage Current (Note 6)      | IR               | -    | 0.1  | 1.0  | μA   | $V_{P} = 5V, V_{N} = 0V$                         |
| Reverse breakdown voltage             | V <sub>BR</sub>  | 6.0  | -    | -    | V    | I <sub>R</sub> = 1mA                             |
| Clamping Voltage, Positive Transients | V <sub>CL1</sub> | -    | 10.0 | -    | V    | I <sub>PP</sub> = 1A (Note 7)                    |
| Clamping Voltage, Negative Transients | V <sub>CL2</sub> | -    | -1.7 | -    | V    | I <sub>PP</sub> = -1A (Note 7)                   |
| Forward Voltage for Top Diode         | V <sub>FD1</sub> | 0.60 | 0.80 | 0.95 | V    | $I_F = 8mA$ , any channel to $V_P$               |
| Forward Voltage for Bottom Diode      | V <sub>FD2</sub> | 0.60 | 0.80 | 0.95 | V    | $I_F = 8mA$ , $V_N$ to and channel               |
| Dynamic Resistance                    | R <sub>DYN</sub> | -    | 0.9  | -    | Ω    | I <sub>PP</sub> = 1A (Note 7)                    |
| Channel Input Capacitance             | Ст               | -    | 0.85 | 1.2  | pF   | $V_{IN} = 1.65V, V_P = 3.3V, V_N = 0V, f = 1MHz$ |

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

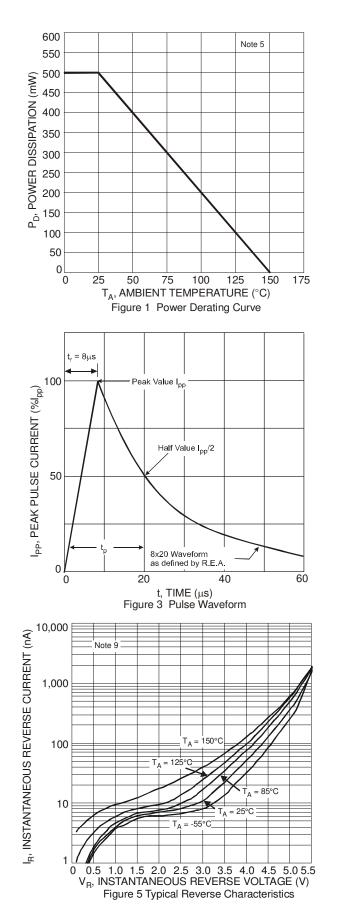
6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an  $8x20\mu s$  peak pulse current ( $I_{pp}$ ) waveform.

8. Measured from any channel to  $V_N$ 9. Measured from VP to VN.

10. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote\_dnote.html.





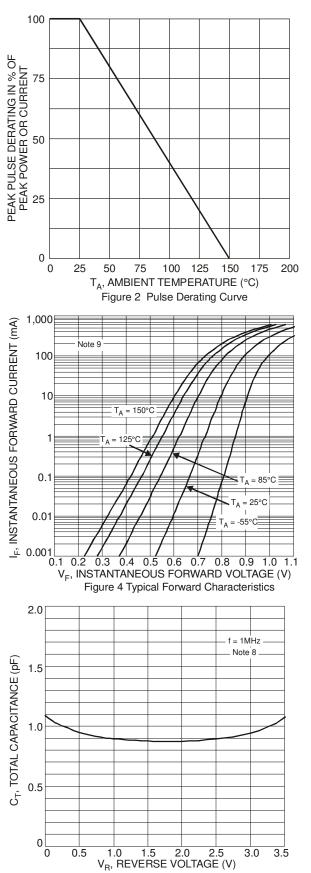
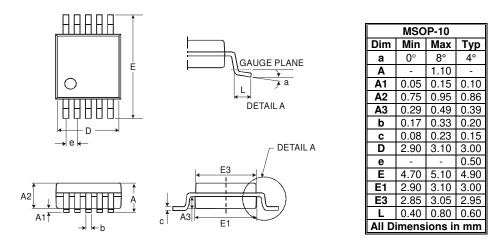


Figure 6 Typical Total Capacitance vs. Reverse Voltage



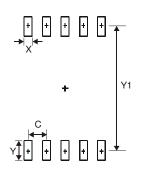
# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 5.300         |
| Х          | 0.300         |
| Y          | 1.350         |
| Y1         | 0.500         |



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